



I HEREBY CERTIFY THAT THIS CORRESPONDENCE IS BEING DEPOSITED WITH THE UNITED STATES POSTAL SERVICE AS FIRST CLASS MAIL IN AN ENVELOPE ADDRESSED TO: COMMISSIONER FOR PATENTS, P.O. BOX 150, ALEXANDRIA, VA 22313-1450 ON THE DATE INDICATED BELOW

BY

Diana Marks

DATE

July 27, 2005

MAIL STOP ISSUE FEE - DRAWINGS

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re:	Patent Application of Tuung Luoh	:	Attn: Official Draftsperson Group Art Unit 2818
Conf. No.:	5065	:	Allowed May 26, 2005
Appln. No.	10/715,558	:	
Filed:	November 19, 2003	:	Attorney Docket No. 681939-44 (P910137)
For:	METHOD OF FORMING A POLYSILICON LAYER COMPRISING MICROCRYSTALLINE GRAINS	:	

**TRANSMITTAL OF FORMAL DRAWINGS**

In accordance with the Notice of Allowability accompanying the Notice of Allowance mailed May 26, 2005, enclosed are one (1) sheet of formal drawings, Figs. 1 through 3, concerning the above-identified application.

It is respectfully submitted that the enclosed copies of formal drawings place this application in condition to be issued, the issue fee being paid concurrently herewith.

Respectfully submitted,

July 27, 2005  
(Date)

By:

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